

## 54FCT541 Non-Inverting Octal Buffer/Line Driver with TRI-STATE® Outputs

#### **General Description**

The 'FCT541 is a non-inverting octal buffer and line driver designed to be employed as a memory address driver, clock driver and bus oriented transmitter or receiver which provides improved PC board density.

The FCT541 is functionally equivalent to the FCT 241 with the exception of packaging, inputs and outputs are on the opposite side of the package.

FACT™ FCT utilizes NSC quiet series technology to provide improved quiet output switching and dynamic threshold performance.

FACT FCT features undershoot corrector and split ground bus for superior performance.

# Ordering Code: See Section 8

#### Logic Symbol

OE.

OE<sub>2</sub>

10

I,

5

Iz

L

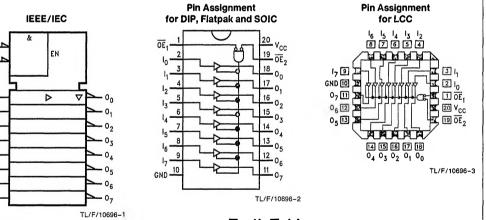
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- NSC 54FCT541 is pin and functionally equivalent to IDT 54FCT541
- Input clamp diodes to limit bus reflections
- TTL/CMOS input and output level compatible
- $I_{OI} = 48 \text{ mA}$
- CMOS power levels
- 2 kV minimum ESD immunity
- Military product compliant to MIL-STD 883 and standard military drawing #5962-89766

### **Connection Diagrams**



Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$ $I_0 - I_7$	TRI-STATE Output Enable Inputs
0 <sub>0</sub> -0 <sub>7</sub>	Outputs

#### **Truth Table**

	Inputs					
OE1	OE <sub>2</sub>	l <sub>n</sub>	Outputs			
L	L	н	н			
н	X	X	Z			
X	н	X	Z			
L	L	L	L			

H = HIGH Voltage Level

L = LOW Voltage Level X = Immaterial

Z = High Impedance

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#### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Terminal Voltage with Respect to GND (VTERM)	
54FCT	-0.5V to 7.0V
Temperature under Bias (T <sub>BIAS</sub> ) 54FCT	-65°C to +135°C
Storage Temperature (T <sub>STG</sub> ) 54FCT	-65°C to +150°C
Power Dissipation (PT)	0.5W
DC Output Current (IOUT)	120 mA

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. Exposure to absolute maximum rating conditions for extended periods may affect reliability. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables.

# Recommended Operating Conditions

Supply Voltage (V <sub>CC</sub> ) 54FCT	4.5V to 5.5V
Input Voltage	0V to V <sub>CC</sub>
Output Voltage	0V to V <sub>CC</sub>
Operating Temperature (T <sub>A</sub> ) 54FCT	-55°C to +125°C
Junction Temperature (Tj) CDIP PDIP	175°C 140°C

#### **DC Characteristics for 'FCT Family Devices**

Typical values are at V<sub>CC</sub> = 5.0V, 25°C ambient and maximum loading. For test conditions shown as Max, use the value specified for the appropriate device type: Com: V<sub>CC</sub> = 5.0V ±5%, Mil: V<sub>CC</sub> = 5.0V ±10%, T<sub>A</sub> = -55°C to + 125°C, V<sub>HC</sub> = V<sub>CC</sub> - 0.2V.

Symbol	Parameter	54FCT			Units	Conditions		
Cymbol		Min	Тур	Max	Units	Conditions		
VIH	Minimum High Level Input Voltage	2.0			v			
VIL	Maximum Low Level Input Voltage			0.8	v			
lн	Input High Current			5.0 5.0	μΑ	V <sub>CC</sub> = Max	$V_I = V_{CC}$ $V_I = 2.7V$ (Note 2)	
Ι <sub>ΙL</sub>	Input Low Current			-5.0 -5.0	μA	V <sub>CC</sub> = Max	$V_I = 0.5V$ (Note 2) $V_I = GND$	
loz	Maximum TRI-STATE Current			10.0 10.0 - 10.0 - 10.0	μΑ	V <sub>CC</sub> = Max	$V_{O} = V_{CC}$ $V_{O} = 2.7V (Note 2)$ $V_{O} = 0.5V (Note 2)$ $V_{O} = GND$	
V <sub>IK</sub>	Clamp Diode Voltage		-0.7	- 1.2	V	$V_{CC} = Min; I_N = -18 \text{ mA}$		
los	Short Circuit Current	-60	- 120		mA	V <sub>CC</sub> = Max (Note 1);	V <sub>O</sub> = GND	
V <sub>OH</sub> Minimum High Level		2.8	3.0			$V_{CC} = 3V; V_{IN} = 0.2V \text{ or } V_{HC}; I_{OH} = -32$		
	Output Voltage	V <sub>HC</sub> 2.4 2.4	V <sub>CC</sub> 4.3 4.3		v	$V_{CC} = Min$ $V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -300 \ \mu A$ $I_{OH} = -12 \ mA (Mil)$ $I_{OH} = -15 \ mA (Com)$	
V <sub>OL</sub>	Maximum Low Level		GND	0.2	$V_{\rm CC} = 3V; V_{\rm IN} = 0.2$		V or V <sub>HC</sub> ; I <sub>OL</sub> = 300 μA	
	Output Voltage	1	GND 0.3 0.3	0.2 0.55 0.55	v	V <sub>CC</sub> = Min V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 300 \ \mu A$ $I_{OL} = 48 \ mA (Mil)$ $I_{OL} = 64 \ mA (Com)$	
lcc	Maximum Quiescent Supply Current		0.001	1.5	mA	$\label{eq:V_CC} \begin{split} V_{CC} &= Max \\ V_{IN} \geq V_{HC}, V_{IN} \leq 0.2 \\ f_I &= 0 \end{split}$	2V	
ΔI <sub>CC</sub>	Quiescent Supply Current; TTL Inputs HIGH		0.5	2.0	mA	V <sub>CC</sub> = Max V <sub>IN</sub> = 3.4V (Note 3)		

#### DC Characteristics for 'FCT Family Devices (Continued)

Typical values are at V<sub>CC</sub> = 5.0V, 25°C ambient and maximum loading. For test conditions shown as Max, use the value specified for the appropriate device type: Com: V<sub>CC</sub> = 5.0V  $\pm$  5%, T<sub>A</sub> = 0°C to +70°C; Mil: V<sub>CC</sub> = 5.0V  $\pm$  10%, T<sub>A</sub> = -55°C to +125°C, V<sub>HC</sub> = V<sub>CC</sub> - 0.2V.

Symbol	Parameter	54FCT			Units	Conditions		
	rarameter	Min	Тур	Max	Unita	Conditions		
ICCD	Dynamic Power Supply Current (Note 4)		0.35	0.40	mA/MHz	$\begin{array}{l} V_{CC} = Max \\ Outputs Open \\ \overline{OE}_A = \overline{OE}_B = GND \\ One Input Toggling \\ 50\% Duty Cycle \end{array}$	$V_{IN} \ge V_{HC}$ $V_{IN} \le 0.2V$	
lc	Total Power Supply Current (Note 6)			5.5		$V_{CC} = Max$ Outputs Open $\overline{OE}_A = \overline{OE}_B = GND$	V <sub>IN</sub> ≥ V <sub>HC</sub> V <sub>IN</sub> ≤ 0.2V	
				6.0	mA	f <sub>I</sub> = 10 MHz One Bit Toggling 50% Duty Cycle	$V_{IN} = 3.4V$ $V_{IN} = GND$	
						(Note 5) $V_{CC} = Max$ $\overline{OE}_A = \overline{OE}_B = GND$	$V_{IN} \ge V_{HC}$ $V_{IN} \le 0.2V$	
						f <sub>I</sub> = 2.5 MHz Eight Bits Toggling 50% Duty Cycle	V <sub>IN</sub> = 3.4V	

Note 1: Maximum test duration not to exceed one second, not more than one output shorted at one time.

Note 2: This parameter guaranteed but not tested.

Note 3: Per TTL driven input ( $V_{IN}$  = 3.4V); all other inputs at  $V_{CC}$  or GND.

Note 4: This parameter is not directly testable, but is derived for use in Total Power Supply calculations.

Note 5: Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are guaranteed but not tested.

Note 6: I<sub>C</sub> = I<sub>QUIESCENT</sub> + I<sub>INPUTS</sub> + I<sub>DYNAMIC</sub>

 $I_{C} = I_{CC} + \Delta I_{CC} D_{H} N_{T} + I_{CCD} (f_{CP}/2 + f_{I} N_{I})$ 

I<sub>CC</sub> = Quiescent Current

 $\Delta I_{CC}$  = Power Supply Current for a TTL High Input (V<sub>IN</sub> = 3.4V)

 $D_H = Duty Cycle for TTL Inputs High$ 

 $N_T = Number of Inputs at D_H$ 

I<sub>CCD</sub> = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

f<sub>CP</sub> = Clock Frequency for Register Devices (Zero for Non-Register Devices)

f<sub>I</sub> = Input Frequency

NI = Number of inputs at fi

All currents are milliamps and all frequencies are in megahertz.

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		54FCT/74FCT	74F	СТ	54	FCT		
Symbol Parameter	$T_{A} = +25^{\circ}C$ $V_{CC} = 5.0V$	$T_{A}, V_{CC} = Com$ $R_{L} = 500\Omega$ $C_{L} = 50 \text{ pF}$		$T_{A}, V_{CC} = MII$ $R_{L} = 500\Omega$ $C_{L} = 50 \text{ pF}$		Units	Fig. No.	
	Тур	Min	Max	Min	Max			
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay D <sub>n</sub> to O <sub>n</sub>	5.0			1.5	9.0	ns	2-8
tpzH tpzL	Output Enable Time	7.0			1.5	12.5	ns	2-1
t <sub>PHZ</sub> tPLZ	Output Disable Time	6.0			1.5	9.5	ns	2-1

# Capacitance $T_A = +25^{\circ}C$ , f = 1.0 MHz

Symbol	Parameter (Note)	Тур	Max	Units	Conditions
CIN	Input Capacitance	6	8	pF	V <sub>IN</sub> = 0V

Note: This parameter is measured at characterization but not tested.